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() Final Specifications

Module	15.6" (15.55") FHD 16:9 Color TFT-LCD with LED Backlight design				
Model Name	B156HAK03.0 (H/W:2A)				
Note (🗭)	o-TP Display				

Customer	Date	App	proved by	Date
Checked & Approved by	Date	Pre	pared by	Date
		<u>Er</u>	ric DCLiu	<u>2016/12/30</u>
Note: This Specification is so change without notice.	ubject to		NBBU Marke AU Optronic	ting Division s corporation



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Record of Revision

Version and Date		Page	Old description	New Description	Remark
0.1	2016/12/05	All	First Edition for Customer		
0.2 2016/12/21		P.5,& P.7	White Luminance 220typ/187min	White Luminance 235typ/200min	
		P.31		Update carton package	
0.3	2016/12/30	P. 5	Power Consumption 4.4W	Power Consumption 4.2W	
		P. 6	Interface :USB or I2C	Interface :I2C	
		P. 6		Report Rate/ Multi-Touch Point/ Distance between 2 point :TBD	
		P. 6	Support OS:Windows 10	Support OS:Chrome	
		P. 6	Touch panel sensor IC :TBD	Touch panel sensor IC : Raydium (RM32380)	
		P. 15	VDD Power :1.2W (max)	VDD Power :1.0W (max)	
		P. 15	IDD Current: 400 mA(max)	IDD Current: 333 mA(max)	
		P. 33		Update EDID	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electronic breakdown.



2. General Description

B156HAK03.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 FHD, 1920(H) x 1080(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP(Embedded DisplayPort) interface compatible.

B156HAK03.0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}$ C condition:

Items	Unit	Specification	ns					
Screen Diagonal	[mm]	394.9						
Active Area	[mm]	344.16 x 193	344.16 x 193.59					
Pixels H x V		1920 x 3(RG	B) x 1080					
Pixel Pitch	[mm]	0.17925 x 0.	17925					
Pixel Format		R.G.B. Verti	cal Stripe					
Display Mode		Normally Blo	ack					
White Luminance (ILED= 24 mA) (Note: ILED is LED current)	[cd/m ²]		235 typ. (5 points average) (Total Solution) 200min. (5 points average) (Total Solution)					
Luminance Uniformity		1.25 max. (5	5 points)					
Contrast Ratio		800:1 typ						
Response Time	[ms]	25 Tvp						
Nominal Input Voltage VDD	[Volt]	+3.3 typ.						
Power Consumption	[Watt]	4.2W						
Weight	[Grams]	370 max.						
			Min.	Тур.	Max.			
Physical Size		Length	359.00	359.50	360.00			
Include bracket	[mm]	Width	223.30	223.80	224.30			
Thicknessss		Thicknessss	3.2 (Panel side) 3.4 (PCB side)					
Electrical Interface		2 Lane eDP	1					
Glass Thickness	[mm]	0.4						
Surface Treatment		Glare						
Support Color		262K colors	(RGB 6-bit)				
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60						
RoHS Compliance		RoHS Compliance						



2.1.1 General Touch Specification

Item	Spec	Unit
Type of Touch Sensor	Projective Capacitive (on cell)	
Panel Size	15.6''	
Outline Dimension	NA(cover lens free)	mm
Total Thickness	NA(cover lens free)	mm
Total Weight	NA(cover lens free)	g
TP View Area	NA(cover lens free)	mm
TP Active Area	346.36 x 195.79	mm
Interface	I2C	
Report Rate	TBD	Hz
Multi-Touch Point	TBD	
Input method	Finger	
Touch panel sensor IC	Raydium (RM32380)	
Channel	82(Rx) x 46(Tx)	
Distance between 2 point	TBD	mm
Surface treatment	NA	
TP F/W version	TBD	
Support OS	Chrome	
BM ink	NA	
TP Power Consumption	TBD	mW

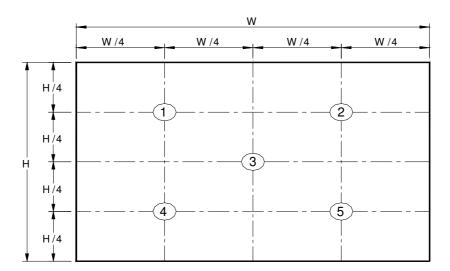


2.2 Optical Characteristics

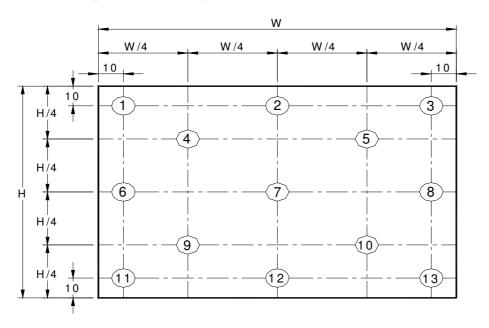
The optical characteristics are measured under stable conditions at 25% (Room Temperature) :

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
	White Luminance ILED=24mA		5 points average	200	235	-	cd/m²	1, 4, 5.
		Θ_{R}	Horizontal (Right)	80	85	-	degree	
Viewing Ar	aglo	θL	CR = 10 (Left)	80	85	-		
Viewing Ai	igie	Ψн	Vertical (Upper)	80	85	-		4, 9
		Ψι	CR = 10 (Lower)	80	85	-		
Luminance Un	iformity	δ_{5P}	5 Points	-	-	1.25		1, 3, 4
Luminance Un	iformity	δ _{13P}	13 Points	-	-	1.60		2, 3, 4
Contrast R	atio	CR		-	800	-		4, 6
Cross tal	lk	%				4		4, 7
Response T	Response Time		Rising + Falling	-	25	35		
	Red	Rx		0.542	0.572	0.602		
		Ry		0.313	0.343	0.373		
Color /	Green	Gx		0.320	0.350	0.380		
Chromaticity	J. 55.1	Gy	CIE 1931	0.545	0.575	0.605		4
Coodinates		Bx		0.131	0.161	0.191		4
	Blue	Ву		0.088	0.118	0.148		
		Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC	NTSC			-	45	-		

Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



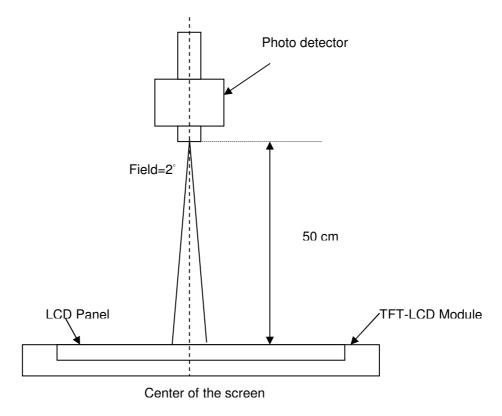
Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

δ w5	=	Maximum Brightness of five points
		Minimum Brightness of five points
δ w13		Maximum Brightness of thirteen points
	=	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the





Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Contrast ratio (CR)= <u>Brightness on the "White" state</u>

Brightness on the "Black" state

Note 7: Definition of Cross Talk (CT)

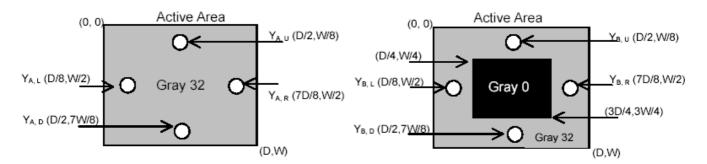
$$CT = | YB - YA | / YA \times 100 (\%)$$

Where

YA = Luminance of measured location without gray level 0 pattern (cd/m2)

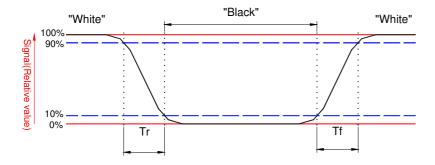
YB = Luminance of measured location with gray level 0 pattern (cd/m2)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

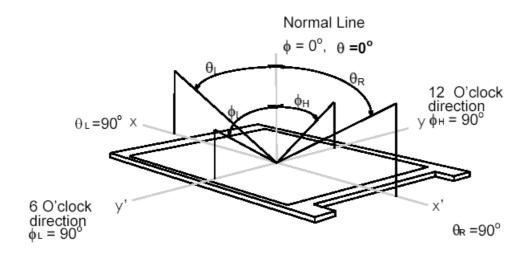




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Note 9. Definition of viewing angle

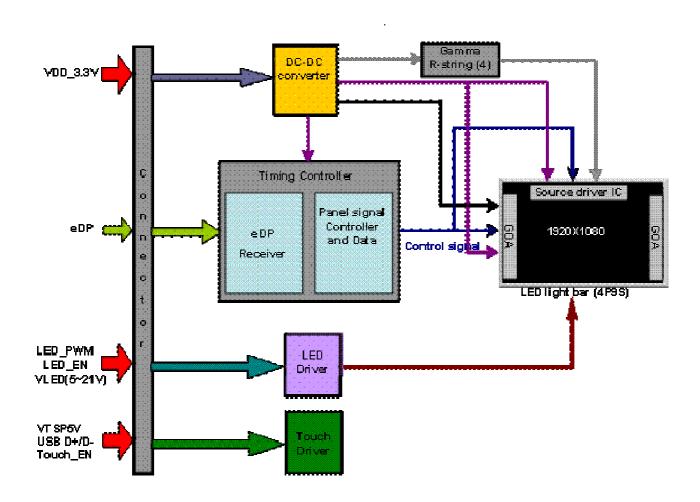
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 15.6 inches wide Color TFT/LCD 40 Pin (One CH/connector Module)





4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.1.2 Absolute Ratinas of Touch Sensor Module

ltem	Symbol	Min	Max	Unit	Conditions
Touch Sensor Module Power Voltage	VTSP	-0.3	7	[Volt]	
Touch Sensor Module Reset Signal	RST	-0.3	3.6	[Volt]	
Touch Sensor Module enable Signal	TP_EN	-0.3	3.6	[Volt]	

4.2 Absolute Ratings of Environment

. 2 / No colore Kallings of Entries in term									
Item	Symbol	Min	Max	Unit	Conditions				
Operating	TOP	0	+50	[°C]	Note 4				
Operation Humidity	HOP	5	95	[%RH]	Note 4				
Storage Temperature	TST	-20	+60	[°C]	Note 4				
Storage Humidity	HST	5	95	[%RH]	Note 4				

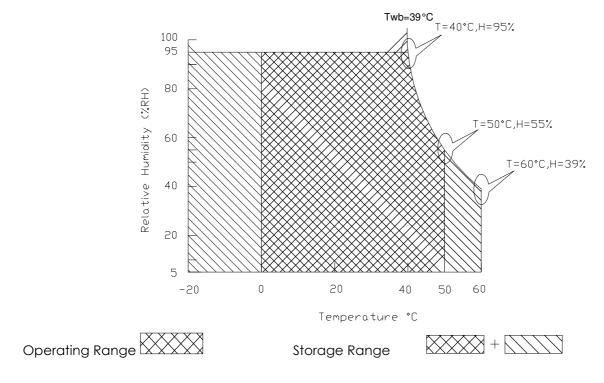
Note 1: At Ta (25°€)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).







5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

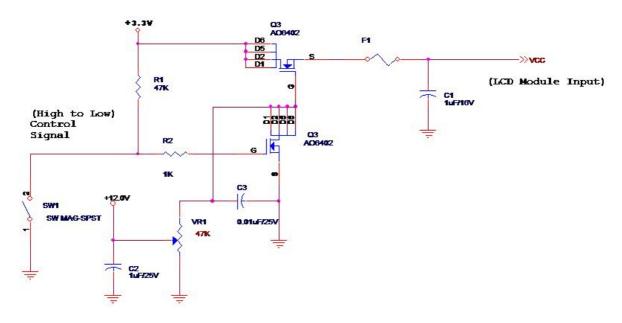
Input power specifications are as follows;

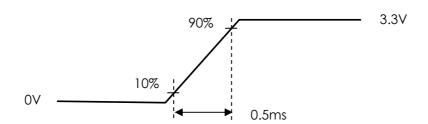
The power specification are measured under 25° C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	1.0	[Watt]	Note 1
IDD	IDD Current	-	-	333	[mA]	Note 1
IRush	Inrush Current	-	-	1500	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Mosaic Pattern at 3.3V driving voltage. (Pmax=V3.3 x lblack)

Note 2: Measure Condition

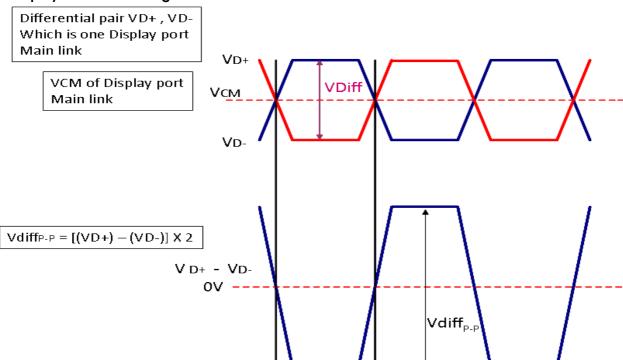




5.1.2 Signal Electrical Characteristics

Signal electrical characteristics are as follows;

Display Port main link signal:

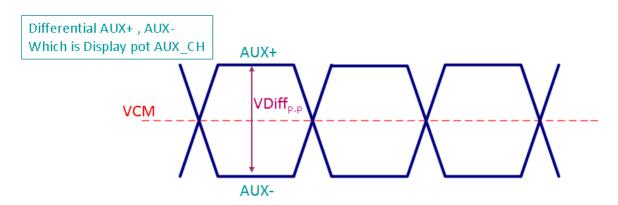


Input signals shall be low or High-impedance state when VDD is off.

Display port main link										
		Min	Тур	Max	unit					
VCM	RX input DC Common Mode Voltage		0		٧					
VDiff _{P-P}	Peak-to-peak Voltage at a receiving Device	150		1320	mV					

Follow as VESA display port standard V1.3

Display Port AUX_CH signal:





	Display port AUX_CH										
		Min	Тур	Max	unit						
VCM	AUX DC Common Mode Voltage		0		V						
VDiff _{P-P}	AUX Peak-to-peak Voltage at a receiving Device	270	-	800	mV						

Follow as VESA display port standard V1.3

Display Port VHPD signal:

	Display port VHPD										
		Min	Тур	Max	unit						
VHPD	HPD Voltage	2.25	ı	3.6	٧						

Follow as VESA display port standard V1.3



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5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol Min Typ				Units	Condition
Backlight Power Consumption	PLED	-	-	3.20	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	15,000	-	-	Hour	(Ta=25°C), Note 2 I _F =23 mA

Note 1: Calculator value for reference PLED = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	5.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED_EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	*Note 1	-	-	0.5	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.5	-	5.5	[Volt]	Define as
PWM Logic Input Low Level	*Note 1	-	-	0.5	[Volt]	Connector
PWM Input Frequency	FPWM	200	1K	10K	Hz	(Ta=25°C)
PWM Duty Ratio	Duty	5		100	%	

Note 1: Recommend system pull up/down resistor no bigger than 10kohm



5.3.1 Power Specification

Items	Symbol	Sp	ecificatio	Unit	Notes		
iieiii3	Symbol	5 7 .5 6.			Max.	01111	110.00
Touch sensor module	VTSP		3.0	3.3	3.6	V	
Power Supply	V 13r		3.0	5.5	3.6	v	
Touch Sensor Module	VTSPrp		_	_	TBD	mV	
Power ripple	ν 1011β				100	11114	
Input Voltage	RST, TP_EN	VIH	TBD		TBD	٧	
input voltage	VIL		TBD		TBD	٧	



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		1																			19	20)
1st Line	R	G	В	R	G	В		-	-	-		-	-	-	-		-	R	G	В	R	G	В
		•			1																	•	
		•			•														•			•	
		•			•																	•	
					1														· •				
		,																					
1080th Line	R	G	В	R	G	В	-		-	-	-	-	-		-	-	-	R	G	В	R	G	В



6.2 Integration Interface Requirement

6.2.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	I-PEX or compatible
Type / Part Number	I-PEX 20455-040E-76B or compatible
Mating Housing/Part Number	I-PEX 20453 or compatible

6.2.2 Pin Assignment

eDP lane is a differential signal technology for LCD interface and high speed data transfer device.

PIN NO	Symbol	Function
1	NC	No Connect (Reserved)
2	H_GND	High Speed Ground
3	Lane1_N	Complement signal link lane 1
4	Lane1_P	True signal link lane 1
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test	LCD Panel Self Test Enable
15	LCD GND	LCD logic and driver ground
16	LCD GND	LCD logic and driver ground
17	HPD	HPD signale pin
18	BL_GND	Backlight_ground
19	BL_GND	Backlight_ground
20	BL_GND	Backlight_ground
21	BL_GND	Backlight_ground



22	BL_Enable	Backlight On / Off
23	BL PWM DIM	System PWM signal Input
24	NC	No connect (Reverse for AUO TEST only)
25	NC	No connect (Reverse for AUO TEST only)
26	BL_PWR	Backlight power
27	BL_PWR	Backlight power
28	BL_PWR	Backlight power
29	BL_PWR	Backlight power
30	NC	No Connect (Reserved for CM)
31	TP_D-	USB Data- for Touch
32	TP_D+	USB Data+ for Touch
33	GND	Ground-Shield
34	VTSP	Touch panel power supply (3.3V)
35	VTSP	Touch panel power supply (3.3V)
36	TP_EN	TP Enable (active high)
37	TP_CLK	I2C Clock for Touch (NC for USB input)
38	TP_Data	I2C Data for Touch (NC for USB input)
39	INT	Interrupt for Touch (NC for USB input)
40	RST	Reset for Touch (NC for USB input)

Note1: start from right side

Note2: Input signals shall be low or High-impedance state when VDD is off.



6.3 Interface Timing

Basically, interface timings should match the 1920x1080 /60Hz manufacturing guide line timing.

Parar	neter	Symbol	Min.	Тур.	Max.	Unit	
Frame	e Rate	-	48	60	-	Hz	
Clock fre	equency	1/ T _{Clock}	113.6	142	150	MHz	
	Period	T _V	1126	1126	1080+A		
Vertical	Active	T _{VD}		T Line			
Section	Blanking	T∨B	46	46	Α		
	Period	T _H	2100	2100	1920+B		
Horizontal	Active	T _{HD}			T Clock		
Section	Blanking	T HB	180	180	В		

Note: 1. The above is as optimized setting

2. The maximum clock frequency = (1920+B)*(1080+A)*60 < 150MHz

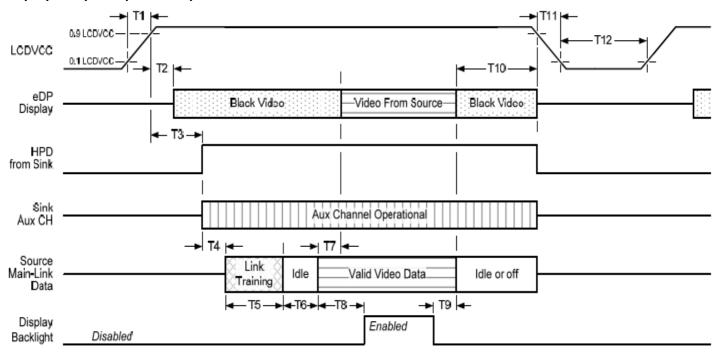


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6.4 Power ON/OFF Sequence

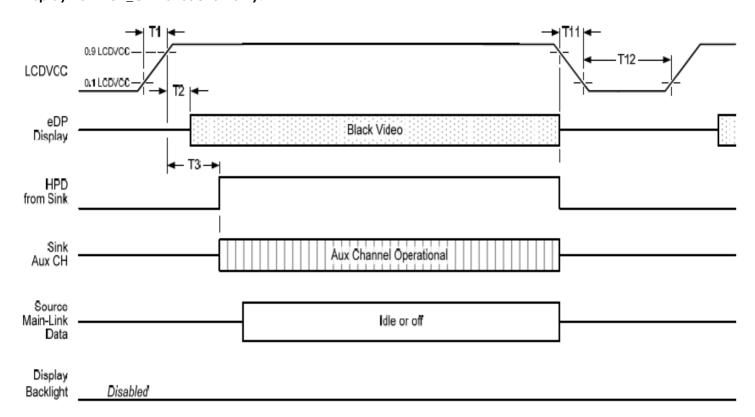
Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off

Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX_CH transaction only:



Display port interface power up/down sequence, AUX_CH transaction only



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Display Port panel power sequence timing parameter:

Timing	Description		Limits			Neces
parameter	Description	Reqd. by	Min.	Тур.	Max.	Notes
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
Т2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
Т3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
Т5	link training duration	source				dependant on source link to read training protocol.
Т6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
17	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
Т8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
Т9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 905 to 10%	source			10ms	
T12	power off time	source	500ms			

Note1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

-upon LCDVDD power on (with in T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).

-when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

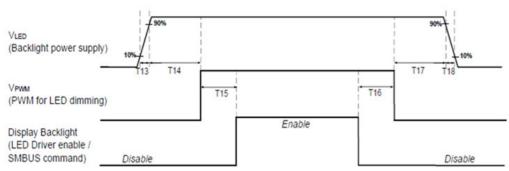
Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.

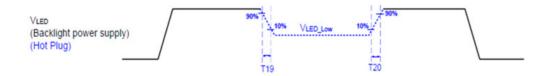
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Display Port panel B/L power sequence timing parameter:



Note: When the adapter is hot plugged, the backlight power supply sequence is shown as below.



	Min (ms)	Max (ms)
T13	0.5	10
T14	10	-
T15	10	-
T16	10	-
T17	10	-
T18	0.5	10
T19	1*	-
T20	1*	-

Seamless change: T19/T20 = 5xT_{PWM}*

^{*}T_{PWM}= 1/PWM Frequency



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7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

1.5 G Acceleration:

Frequency: 10 - 500Hz Random

30 Minutes each Axis (X, Y, Z) Sweep:

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta=0℃, 300h	
High Temperature Storage	Ta= 60℃, 300h	
Low Temperature Storage	Ta= -20℃, 250h	
Thermal Shock Test	Ta=-20 $^{\circ}$ (30min) ~60 $^{\circ}$ (30min), 100cycles condition.	
ESD	Contact : ±8 KV	Note 1
	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

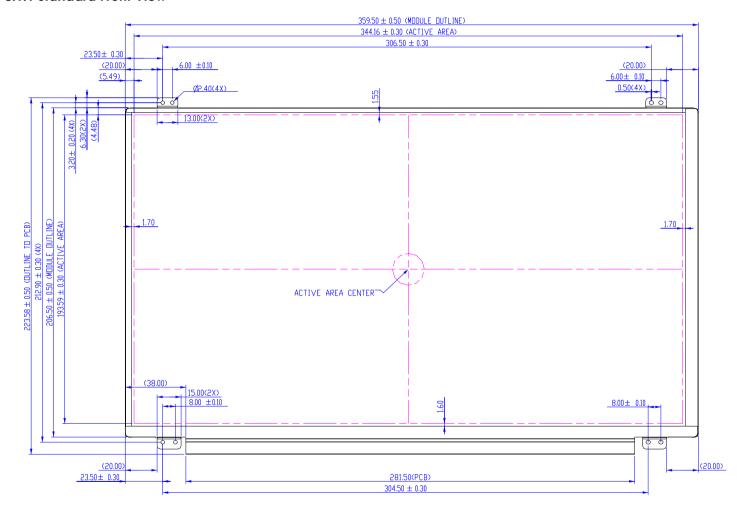
. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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- 8. Mechanical Characteristics
- 8.1 LCM Outline Dimension
- 8.1.1 Standard Front View



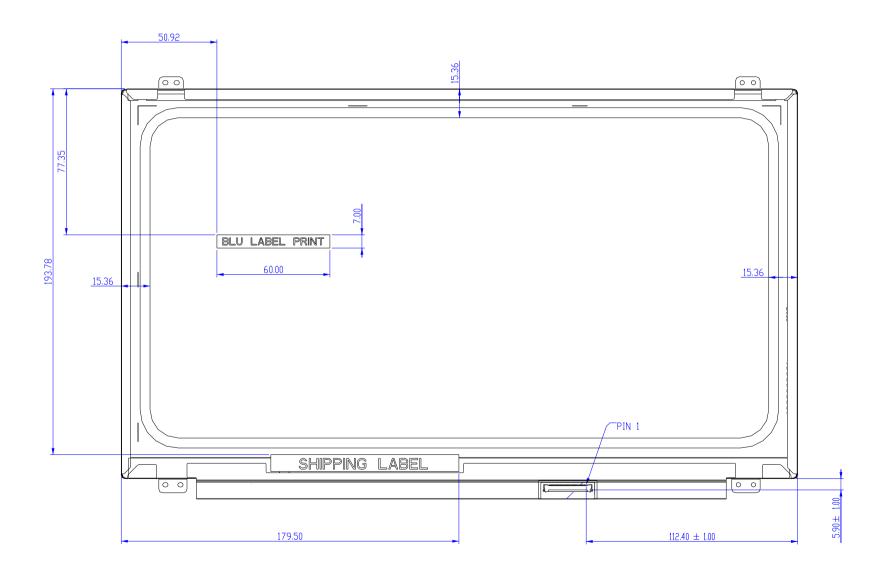


B156HAK03.0 <u>Document Version</u>: 0.3



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8.1.2 Standard Rear View





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9. Shipping and Package

9.1 Shipping Label Format



Manufactured YY/MM Model No: B156HAK03.0

AU Optronics



B156HAK03.0





RoHS



Manufactured YY/MM Model No: B156HAK03.0

All Optronics







RoHS



Manufactured YY/MM Model No: B156HAK03.0 **AU Optronics**

*XXXXXXXXXXXXXXXXXXXXX H/W: 2A F/W:1 MADE IN CHINA(Z31)







RoHS



Manufactured YY/MM Model No: B156HAK03.0

AU Optronics

*XXXXXXXXXXXXXXXXXXXXXX H/W: 2A F/W:1 MADE IN CHINA(Z83)



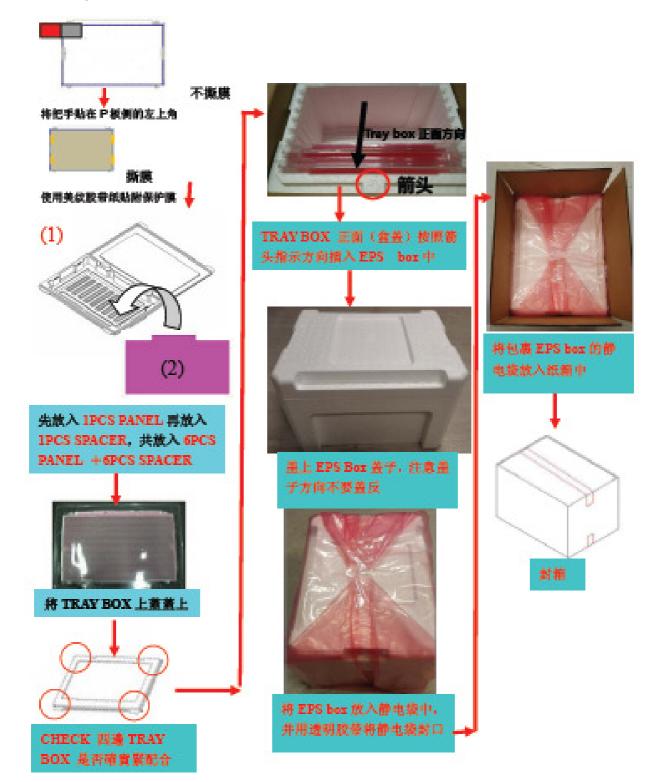
B156HAK03.0





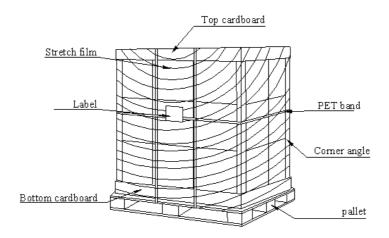


9.2 Carton Package





9.3 Shipping Package of Palletizing Sequence





10. Appendix: EDID Description

<u>Address</u>	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	111111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	ED	11101101	237	
ОВ	hex, LSB first	30	00110000	48	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
OF		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	1B	00011011	27	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
	Video input def. (digital	01	00000100	'	
14	I/P, non-TMDS, CRGB)	95	10010101	149	
	Max H image size				
15	(rounded to cm)	22	00100010	34	
-	Max V image size			-	
16	(rounded to cm)	13	00010011	19	
	Display Gamma				
17	(=(gamma*100)-100)	78	01111000	120	
	Feature support (no DPMS,				
18	Active OFF, RGB, tmg Blk#1)	02	00000010	2	
	Red/green low bits (Lower				
19	2:2:2:2 bits)	ВО	10110000	176	
	Blue/white low bits (Lower				
1 A	2:2:2:2 bits)	E5	11100101	229	
1B	Red x (Upper 8 bits)	94	10010100	148	
1C	Red y/ highER 8 bits	58	01011000	88	
1D	Green x	5A	01011010	90	
1E	Green y	92	10010010	146	
1F	Blue x	28	00101000	40	
20	Blue y	21	00100001	33	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	0000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	



29	1	01	00000001	l 1 l	
27 2A	Standard timing #3	01		1	
	Standard timing #3		00000001	' +	
2B	Chaire alored tipein as # 4	01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	78	01111000	120	
37	Pixel Clock/10000 USB	37	00110111	55	
38	Horz active Lower 8bits	80	10000000	128	
39	Horz blanking Lower 8bits	B4	10110100	180	
	HorzAct:HorzBlnk Upper				
3A	4:4 bits	70	01110000	112	
3B	Vertical Active Lower 8bits	38	00111000	56	
	Vertical Blanking Lower				
3C	8bits	2E	00101110	46	
	Vert Act : Vertical Blanking				
3D	(upper 4:4 bit)	40	01000000	64	
3E	HorzSync. Offset	6C	01101100	108	
3F	HorzSync.Width	30	00110000	48	
	VertSync.Offset:				
40	VertSync.Width	AA	10101010	170	
	Horz‖ Sync Offset/Width	, , , ,	10101010	170	
41	Upper 2bits	00	00000000	0	
	Horizontal Image Size		0000000		
42	Lower 8bits	58	01011000	88	
	Vertical Image Size Lower		01011000	00	
43	8bits	C1	11000001	193	
	Horizontal & Vertical Image		11000001	170	
44	Size (upper 4:4 bits)	10	00010000	16	
	Horizontal Border (zero for		00010000		
45	internal LCD)	00	00000000	0	
	Vertical Border (zero for			-	
46	internal LCD)	00	00000000	0	
	Signal (non-intr, norm, no				
47	stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A	'	00	00000000	0	
4B		OF	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
50 51		00	00000000	0	
				1	
52		00	00000000	0	



53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	111111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	35	00110101	53	5
74	Manufacture P/N	36	00110110	54	6
75	Manufacture P/N	48	01001000	72	Н
76	Manufacture P/N	41	01000001	65	Α
77	Manufacture P/N	4B	01001011	75	K
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	33	00110011	51	3
7A	Manufacture P/N	2E	00101110	46	•
7B	Manufacture P/N	30	00110000	48	0
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	OF	00001111	15	



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10.2 Notes

Acer

- 1) The height of cell tape no higher than top polarizer 3.0mm
- 2) Marking DPCD version, including PSR, PSR2, MBO, VESA DSC,...

DPCD Ver.	PSR	MBO	VESA DSC
1.2	Off	Off	Off

- 3) LED Driving Solution: Minimum change scale duty of the PWM is 0.1% @PWM frequency 200Hz.
- 4) When twisting or pressing LCD module, it may cause unexpected acoustic noises or sounds.
- 5) Maximum value of "Peak current" is as same as "Inruch current" in Electrical Characteristics (Power Specification)
- 6) VDiff_{P-P} (Peak-to-peak Voltage at a receiving Device) follow as VESA display port standard (test point, TP3, is on panel's PCBa)

